

RFM products are now Murata products.

SF1141B-4

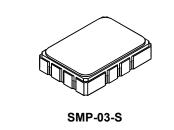
- Designed for SDARS IF Receiver
- · Low Insertion Loss
- 5.0 X 7.0 mm Surface-Mount Case
- · Differential Input and Output
- Complies with Directive 2002/95/EC (RoHS)



Absolute Maximum Ratings

7 to 0 1 at 0 1 at 1 at 1 at 1 at 1 at 1 at			
Rating	Value	Units	
Maximum Incident Power in Passband	+10	dBm	
Max. DC voltage between any 2 terminals	30	VDC	
Storage Temperature Range	-40 to +85	°C	
Max Soldering Profile	265°C for 10 s		





#### **Electrical Characteristics**

Characteristic		Sym	Notes	Min	Тур	Max	Units
Nominal Center Frequency			1	75.000			MHz
Passband Insertion Los		IL	'		12.5	16.0	dB
	1dB Passband	BW <sub>1</sub>		±6.35	±7.43		MHz
	Fast Amplitude Ripple over fc ±6.35 MHz		1, 2			1.5	dB <sub>P-P</sub>
Group Delay Variation over fc ±6.35 MHz					75	200	ns <sub>P-P</sub>
Rejection	fc-100 to fc-18.8 MHz			40	45		
	fc-18.8 to fc-10.95 MHz		1, 2, 3	37	45		dB
	fc+10.95 to fc+18.8 MHz		1, 2, 3	30	36		ив
	fc+18.8 to fc+100 MHz			40	45		
Operating Temperature Range		T <sub>A</sub>	1	-40		+85	°C
Differential Input and Output Impedance		250 ohms					
Case Style		6 SMP-03-S 7 x 5 mm Nominal Footprint			tprint		
Lid Symbolization (YY=year, WW=week, S=shift) See note 4			0	RFM SF1141B-4 YYWWS			

#### **Electrical Connections**

Connection	Port 1 Hot	Port 1 Ground Return or Hot	Port 2 Hot	Port 2 Ground Return or Hot	Case Ground
Terminals	10	1	5	6	All Others

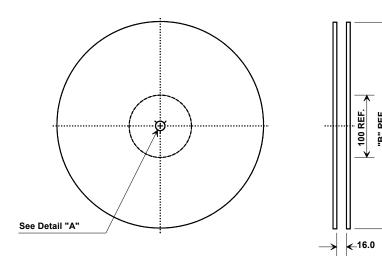


### CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

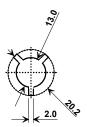
#### NOTES:

- Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with
- Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to  $50 \Omega$  and measured with  $50 \Omega$  network analyzer. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc. The design, manufacturing process, and specifications of this filter are subject to change. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design. US and international patents may apply.

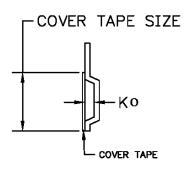
# **Tape and Reel Specifications**



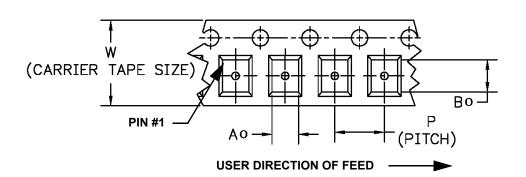
"B " Nominal Size		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	2000



# **COMPONENT ORIENTATION and DIMENSIONS**

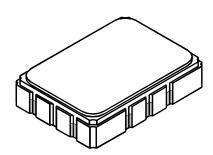


Carrier Tape Dimens	Tolerance	
Ao	5.5 mm	± 0.1mm
Во	7.5 mm	± 0.1mm
Ко	2.0 mm	± 0.1mm
Pitch	8.0 mm	± 0.1mm
W	16.0 mm	± 0.2mm



# SMP-03-S Case 💫

# 12-Terminal Ceramic Surface-Mount Case 5 x 7 mm Nominal Footprint



Case Dimensions						
Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
Α	6.80	7.00	7.20	0.268	0.276	0.283
В	4.80	5.00	5.20	0.189	0.197	0.205
С		1.65	2.00		0.065	0.079
D		0.80				
E	2.41	2.54	2.67	0.095	0.100	0.105
Н	0.87	1.1	1.13	0.034	0.039	0.044
J		2.54				
K	2.87	3.00	3.13	0.113	0.118	0.123
P	1.14	1.27	1.40	0.045	0.050	0.055

Materials			
Solder Pad Termination	Au plating 30 - 60 μinches (76.2-152 μm) over 80- 200 μinches (203-508 μm) Ni.		
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 µinches Thick		
Body	Al <sub>2</sub> O <sub>3</sub> Ceramic		
Pb Free			

